

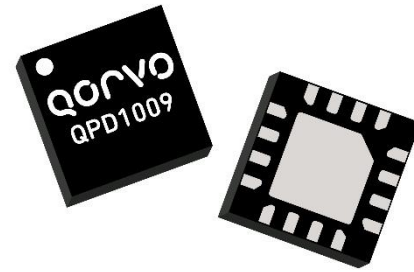
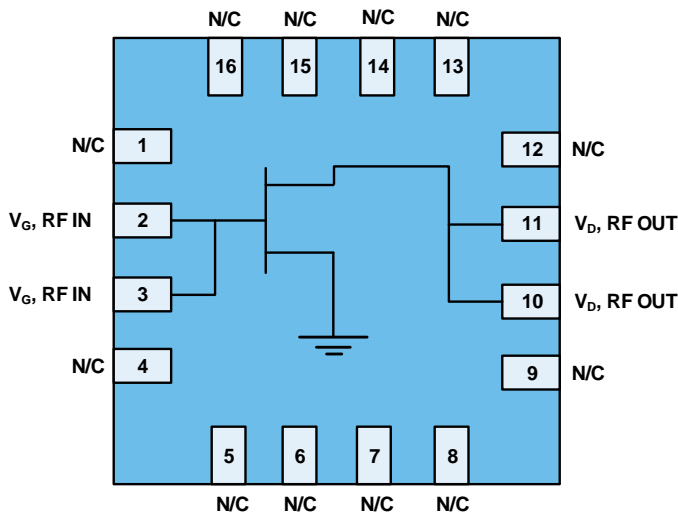
General Description

Qorvo's QPD1009 is a 15 W (P_{3dB}) wideband unmatched discrete GaN on SiC HEMT which operates from DC to 4 GHz and a 50V supply rail. The device is an industry standard 3x3 mm plastic overmold package and is ideally suited to military and civilian radar, land mobile and military radio communications, wireless infrastructure communications, avionics, and test instrumentation. The device can support pulsed, CW and linear operations.

Lead-free and ROHS compliant.

Evaluation boards are available upon request.

Functional Block Diagram



3 x 3 x 0.100 mm

Product Features

- Frequency: DC to 4 GHz
- Output Power (P_{3dB}): 17 W at 2 GHz
- Linear Gain: 24 dB at 2 GHz
- Typical PAE_{3dB} : 72% at 2 GHz
- Operating Voltage: 50 V
- Low thermal resistance package
- CW and Pulse capable
- 3 x 3 mm package

Applications

- Military radar
- Civilian radar
- Land mobile and military radio communications
- Test instrumentation
- Wideband or narrowband amplifiers
- Jammers

Ordering info

Part No.	Description
QPD1009	DC–4 GHz RF Transistor
1132871	0.96 – 1.215 GHz EVB
QPD1009EVB02	1.1 – 1.7 GHz EVB

Absolute Maximum Ratings¹

Parameter	Rating	Units
Breakdown Voltage, BV_{DG}	+145	V
Gate Voltage Range, V_G	-7 to +2	V
Drain Current, I_{DSS}	1600	mA
Gate Current Range, I_G	See page 4.	mA
Power Dissipation, CW, P_{DISS}	16	W
RF Input Power at 2 GHz, CW, 50 Ω , $T = 25^\circ\text{C}$	+27	dBm
Mounting Temperature (30 Seconds)	320	$^\circ\text{C}$
Storage Temperature	-40 to +150	$^\circ\text{C}$

Notes:

1. . Operation of this device outside the parameter ranges given above may cause permanent damage.

Recommended Operating Conditions¹

Parameter	Min	Typ	Max	Units
Operating Temp. Range	-40	+25	+85	$^\circ\text{C}$
Drain Voltage Range, V_D	+12	+50	+60	V
Drain Bias Current, I_{DQ}	–	26	–	mA
Drain Current, I_D	–	700	–	mA
Gate Voltage, V_G	–	-2.8	–	V
Power Dissipation, CW (P_D) ²	–	–	14.4	W
Power Dissipation, Pulsed (P_D) ^{2, 3}	–	–	17.5	W

Notes:

1. Electrical performance is measured under conditions noted in the electrical specifications table. Specifications are not guaranteed over all recommended operating conditions.
2. Package at 85 $^\circ\text{C}$
3. Pulse Width = 128 μs , Duty Cycle = 10%

Pulsed Characterization – Load Pull Performance – Power Tuned

Parameters	Typical Values					Unit
	1	2	3	3.5	4	
Frequency, F	1	2	3	3.5	4	GHz
Linear Gain, G_{LIN}	27	23.7	20.9	19.7	18.7	dB
Output Power at 3dB compression point, P_{3dB}	41.9	42.4	42.4	42.2	41.8	dBm
Power-Added-Efficiency at 3dB compression point, PAE_{3dB}	64.1	67.3	61.4	56.9	50.0	%
Gain at 3dB compression point	24	20.7	17.9	16.7	15.7	dB

Notes:

1. Test conditions unless otherwise noted: $V_D = +50\text{ V}$, $I_{DQ} = 26\text{ mA}$, $Temp = +25\text{ }^\circ\text{C}$

Pulsed Characterization – Load Pull Performance – Efficiency Tuned

Parameters	Typical Values					Unit
	1	2	3	3.5	4	
Frequency	1	2	3	3.5	4	GHz
Linear Gain, G_{LIN}	26.8	24.0	21.8	20.5	19.3	dB
Output Power at 3dB compression point, P_{3dB}	40	41.9	40.9	40.7	41.2	dBm
Power-Added-Efficiency at 3dB compression point, PAE_{3dB}	77.8	72.4	69.6	63.3	54.6	%
Gain at 3dB compression point, G_{3dB}	23.8	21.0	18.8	17.5	16.3	dB

Notes:

1. Test conditions unless otherwise noted: $V_D = +50\text{ V}$, $I_{DQ} = 26\text{ mA}$, $Temp = +25\text{ }^\circ\text{C}$

RF Characterization – 0.96 – 1.215 GHz EVB Performance At 1.09 GHz¹

Parameter	Min	Typ	Max	Units
Linear Gain, G_{LIN}	–	19.5	–	dB
Output Power at 3dB compression point, P_{3dB}	–	41.4	–	dBm
Drain Efficiency at 3dB compression point, $DEFF_{3dB}$	–	53.9	–	%
Gain at 3dB compression point, G_{3dB}	–	16.5	–	dB

Notes:

1. $V_D = +50\text{ V}$, $I_{DQ} = 26\text{ mA}$, $Temp = +25\text{ }^\circ\text{C}$, Pulse Width = 128 μs , Duty Cycle = 10%

RF Characterization – Mismatch Ruggedness at 1.09 GHz

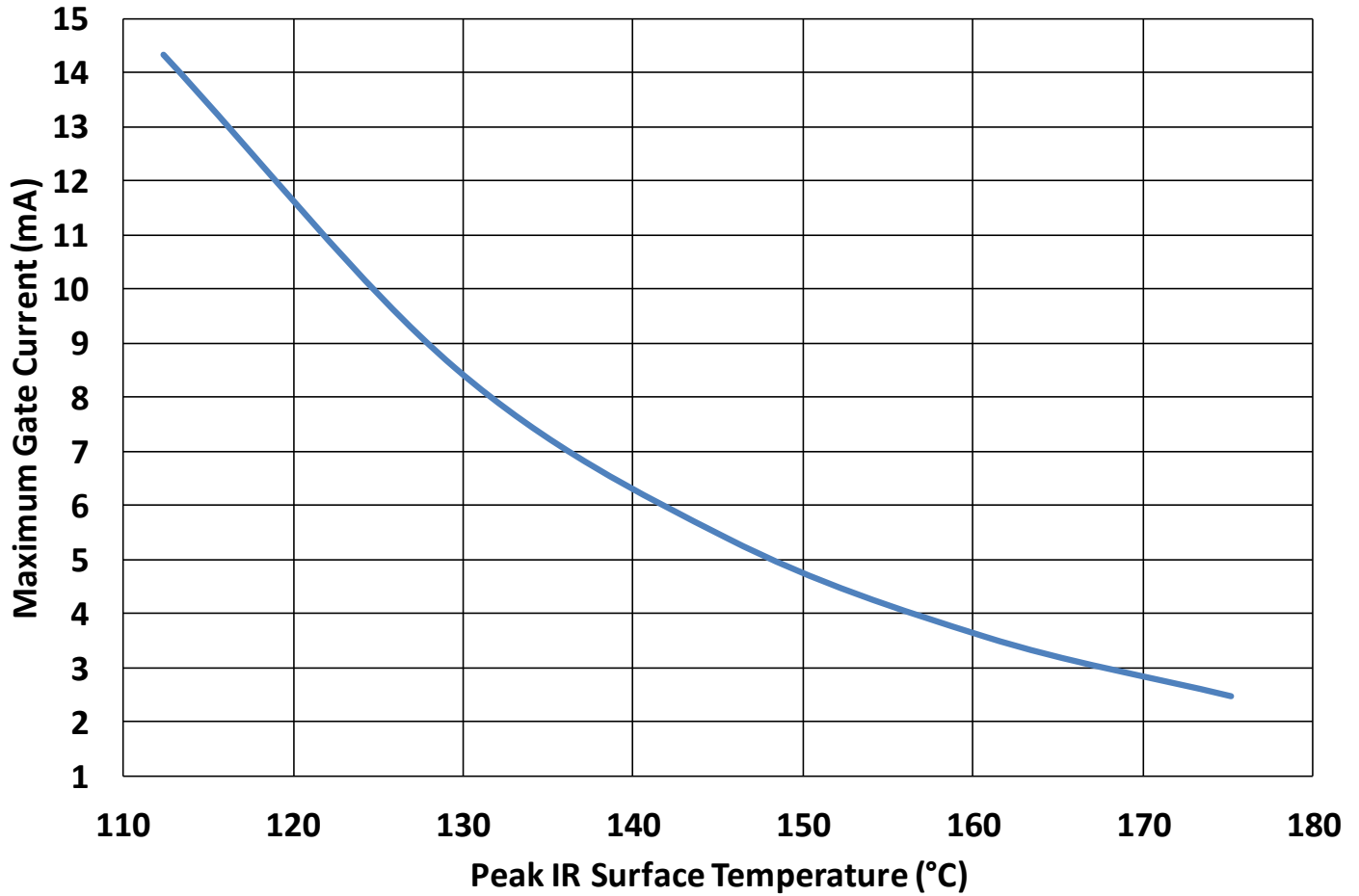
Symbol	Parameter	dB Compression	Typical
VSWR	Impedance Mismatch Ruggedness	3	10:1

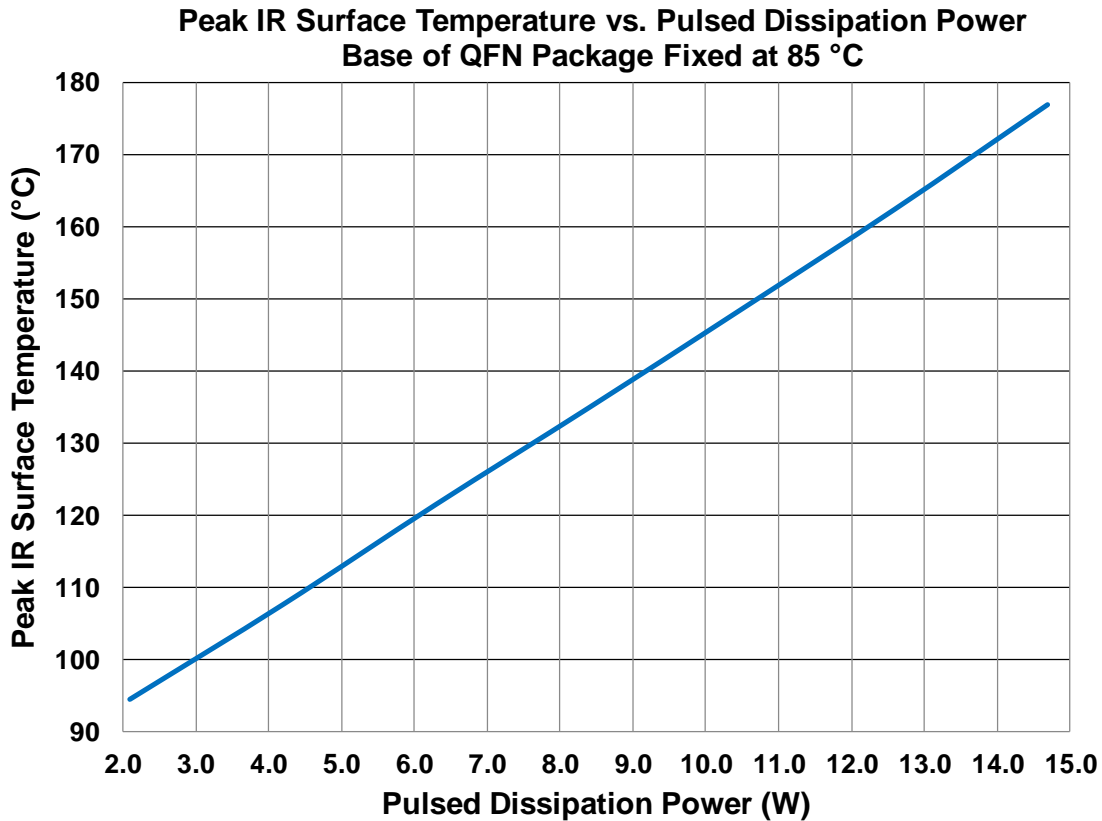
Test conditions unless otherwise noted: $T_A = 25\text{ }^\circ\text{C}$, $V_D = 50\text{ V}$, $I_{DQ} = 26\text{ mA}$

Driving input power is determined at pulsed compression under matched condition at EVB output connector.

Maximum Gate Current

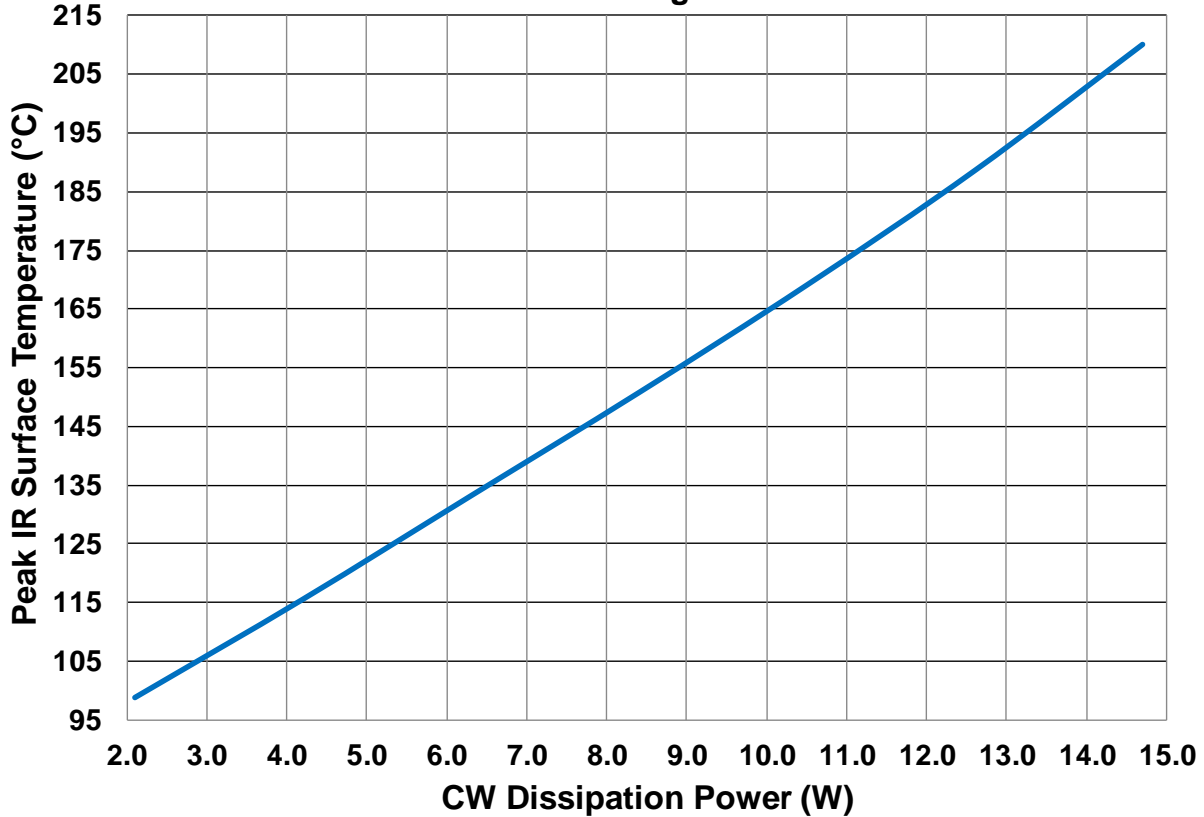
Maximum Gate Current Vs. Peak IR Surface Temperature



Thermal and Reliability Information - Pulsed


Parameter	Conditions	Values	Units
Thermal Resistance, IR ¹ (θ_{JC})	85 °C Case	5.48	°C/W
Peak IR Surface Temperature ¹ (T_{CH})	4.2 W Pdiss, 128 uS PW, 10%	108	°C
Thermal Resistance, IR ¹ (θ_{JC})	85 °C Case	5.87	°C/W
Peak IR Surface Temperature ¹ (T_{CH})	6.3 W Pdiss, 128 uS PW, 10%	122	°C
Thermal Resistance, IR ¹ (θ_{JC})	85 °C Case	5.95	°C/W
Peak IR Surface Temperature ¹ (T_{CH})	8.4 W Pdiss, 128 uS PW, 10%	135	°C
Thermal Resistance, IR ¹ (θ_{JC})	85 °C Case	6.10	°C/W
Peak IR Surface Temperature ¹ (T_{CH})	10.5 W Pdiss, 128 uS PW, 10%	149	°C
Thermal Resistance, IR ¹ (θ_{JC})	85 °C Case	6.11	°C/W
Peak IR Surface Temperature ¹ (T_{CH})	12.6 W Pdiss, 128 uS PW, 10%	162	°C
Thermal Resistance, IR ¹ (θ_{JC})	85 °C Case	6.26	°C/W
Peak IR Surface Temperature ¹ (T_{CH})	14.7 W Pdiss, 128 uS PW, 10%	177	°C

¹Refer to the following document [GaN Device Channel Temperature, Thermal Resistance, and Reliability Estimates](#)

Thermal and Reliability Information - CW
**Peak IR Surface Temperature vs. CW Dissipation Power
Base of QFN Package Fixed at 85 °C**


Parameter	Conditions	Values	Units
Thermal Resistance, IR ¹ (θ_{JC})	85 °C Case	7.38	°C/W
Peak IR Surface Temperature ¹ (T_{CH})	4.2 W Pdiss, CW	116	°C
Thermal Resistance, IR ¹ (θ_{JC})	85 °C Case	7.62	°C/W
Peak IR Surface Temperature ¹ (T_{CH})	6.3 W Pdiss, CW	133	°C
Thermal Resistance, IR ¹ (θ_{JC})	85 °C Case	7.86	°C/W
Peak IR Surface Temperature ¹ (T_{CH})	8.4 W Pdiss, CW	151	°C
Thermal Resistance, IR ¹ (θ_{JC})	85 °C Case	8.00	°C/W
Peak IR Surface Temperature ¹ (T_{CH})	10.5 W Pdiss, CW	169	°C
Thermal Resistance, IR ¹ (θ_{JC})	85 °C Case	8.25	°C/W
Peak IR Surface Temperature ¹ (T_{CH})	12.6 W Pdiss, CW	189	°C
Thermal Resistance, IR ¹ (θ_{JC})	85 °C Case	8.50	°C/W
Peak IR Surface Temperature ¹ (T_{CH})	14.7 W Pdiss, CW	210	°C

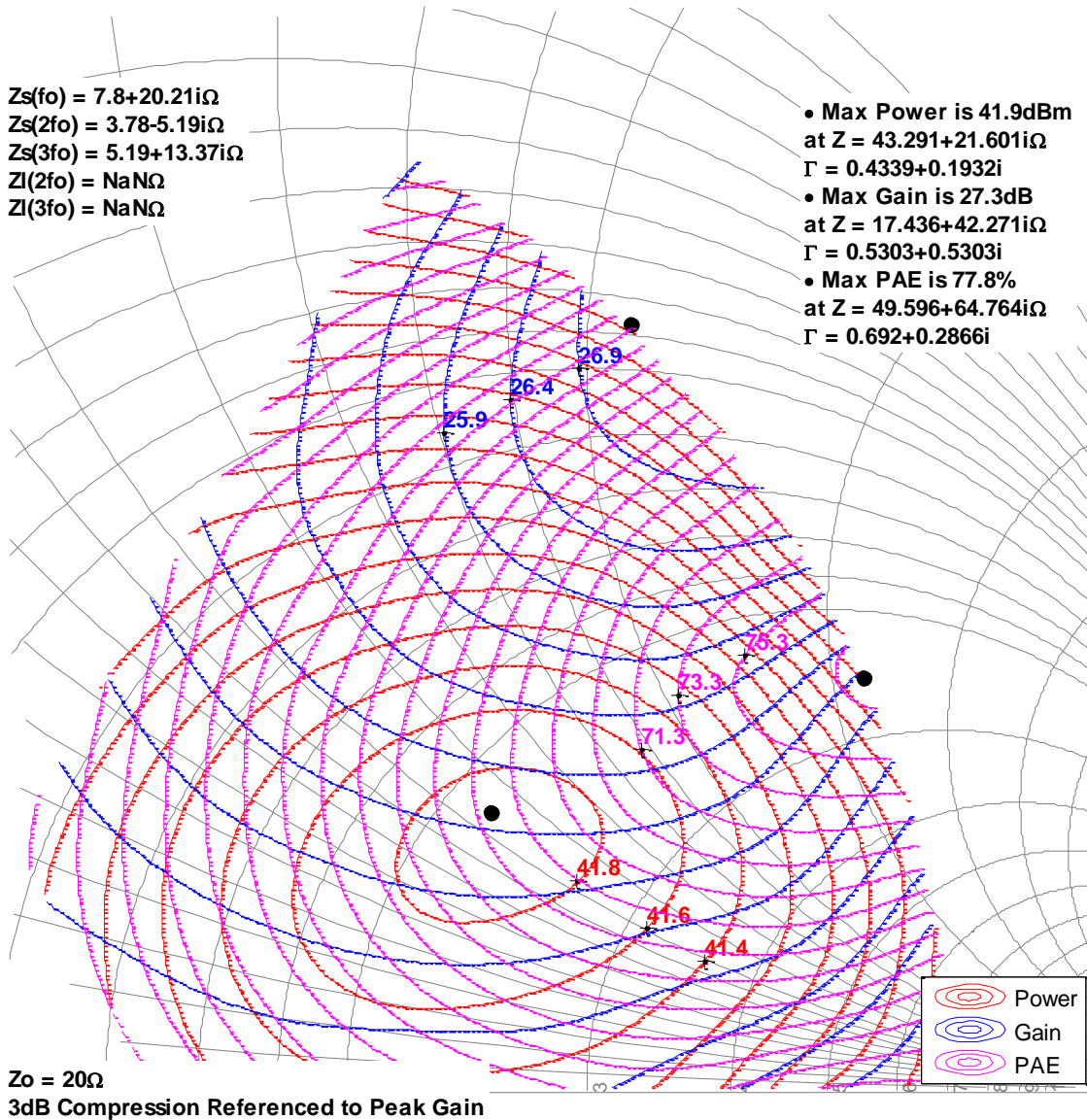
¹Refer to the following document [GaN Device Channel Temperature, Thermal Resistance, and Reliability Estimates](#)

Load Pull Smith Charts^{1, 2, 3}

Notes:

1. $V_d = 50\text{ V}$, $I_{DQ} = 26\text{ mA}$, Pulsed signal with 128 μs pulse width and 10 % duty cycle. Performance is at indicated input power.
2. See page 18 for load pull and source pull reference planes. 20- Ω load pull TRL fixtures are built with 20-mil RO4350B material.
3. NaN means the impedances are either undefined or varying in load-pull system.

1GHz, Load-pull

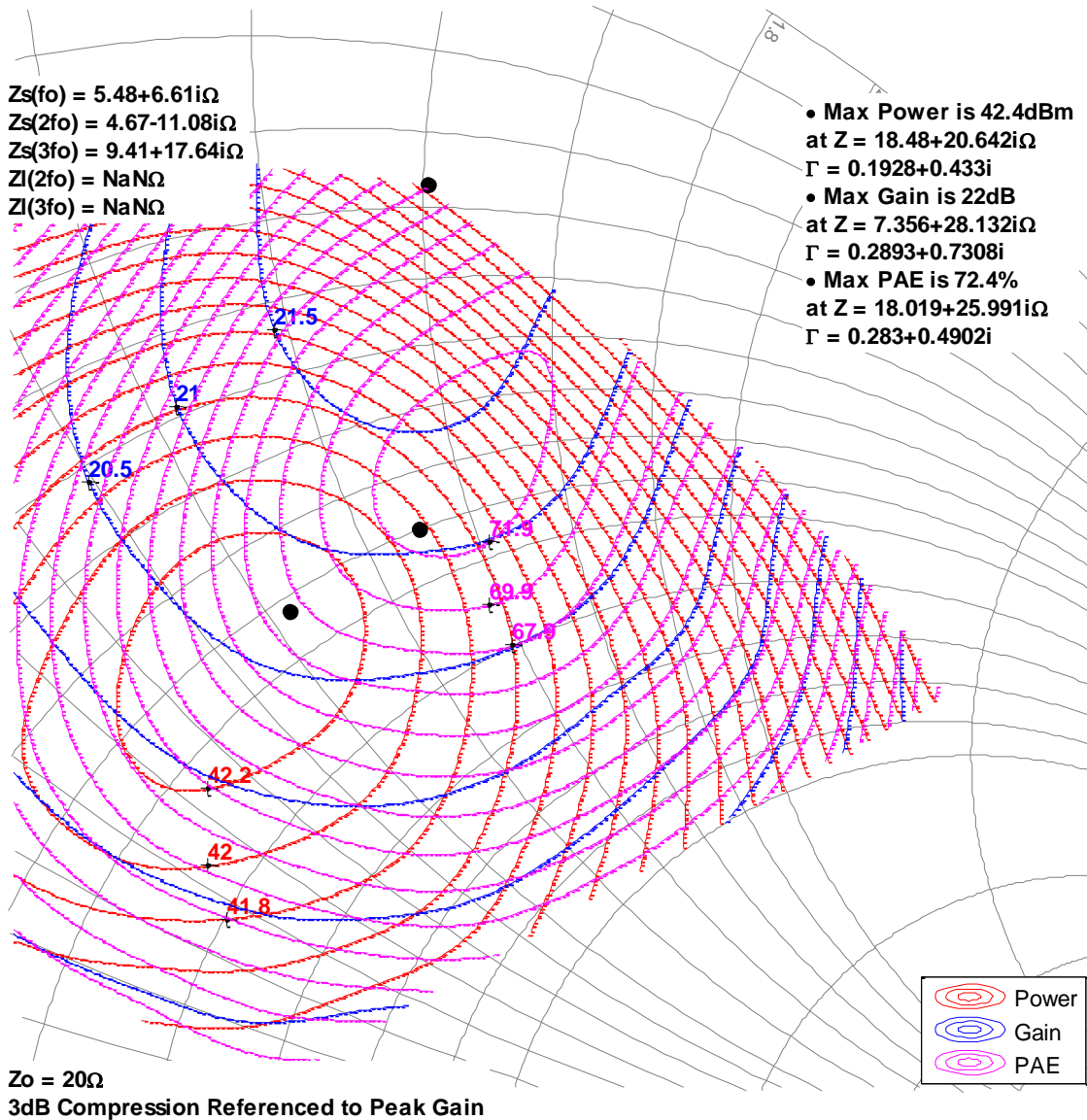


Load Pull Smith Charts^{1, 2, 3}

Notes:

1. $V_d = 50\text{ V}$, $I_{DQ} = 26\text{ mA}$, Pulsed signal with 128 μs pulse width and 10 % duty cycle. Performance is at indicated input power.
2. See page 18 for load pull and source pull reference planes. 20- Ω load pull TRL fixtures are built with 20-mil RO4350B material.
3. NaN means the impedances are either undefined or varying in load-pull system.

2GHz, Load-pull

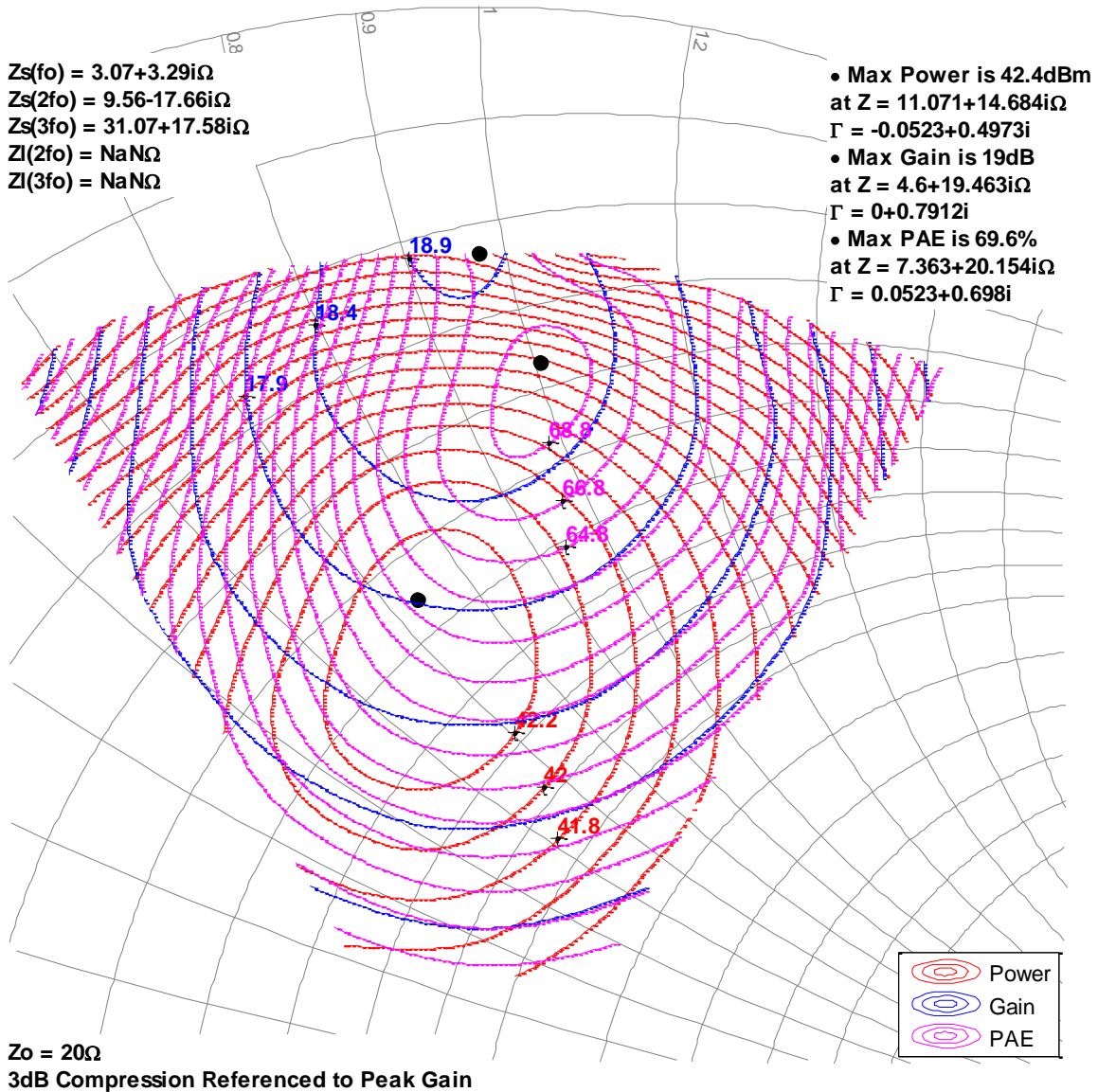


Load Pull Smith Charts^{1, 2, 3}

Notes:

1. $V_d = 50\text{ V}$, $I_{DQ} = 26\text{ mA}$, Pulsed signal with 128 μs pulse width and 10 % duty cycle. Performance is at indicated input power.
2. See page 18 for load pull and source pull reference planes. 20- Ω load pull TRL fixtures are built with 20-mil RO4350B material.
3. NaN means the impedances are either undefined or varying in load-pull system.

3GHz, Load-pull

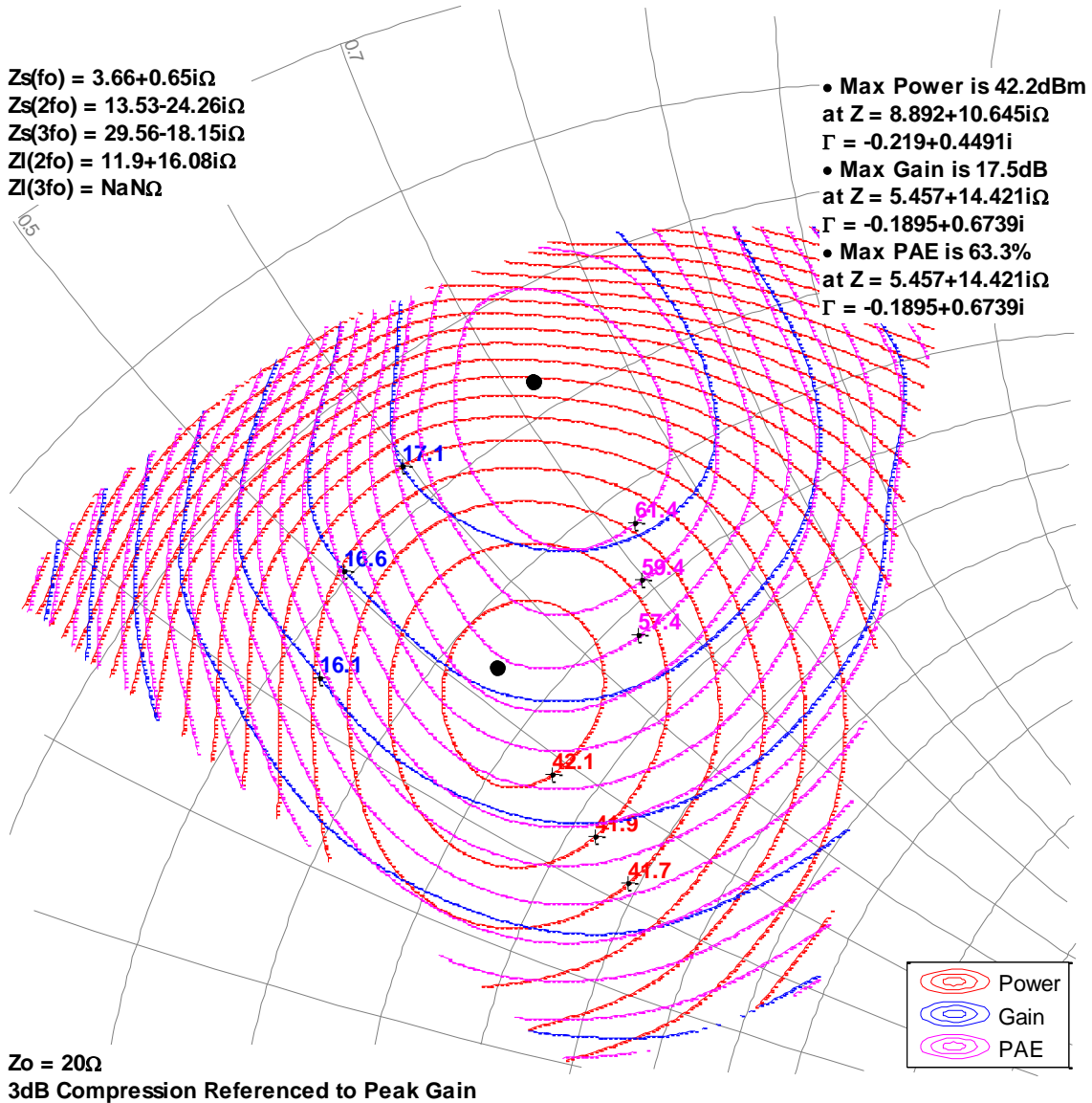


Load Pull Smith Charts^{1, 2, 3}

Notes:

1. $V_d = 50\text{ V}$, $I_{DQ} = 26\text{ mA}$, Pulsed signal with 128 μs pulse width and 10 % duty cycle. Performance is at indicated input power.
2. See page 18 for load pull and source pull reference planes. 20- Ω load pull TRL fixtures are built with 20-mil RO4350B material.
3. NaN means the impedances are either undefined or varying in load-pull system.

3.5GHz, Load-pull

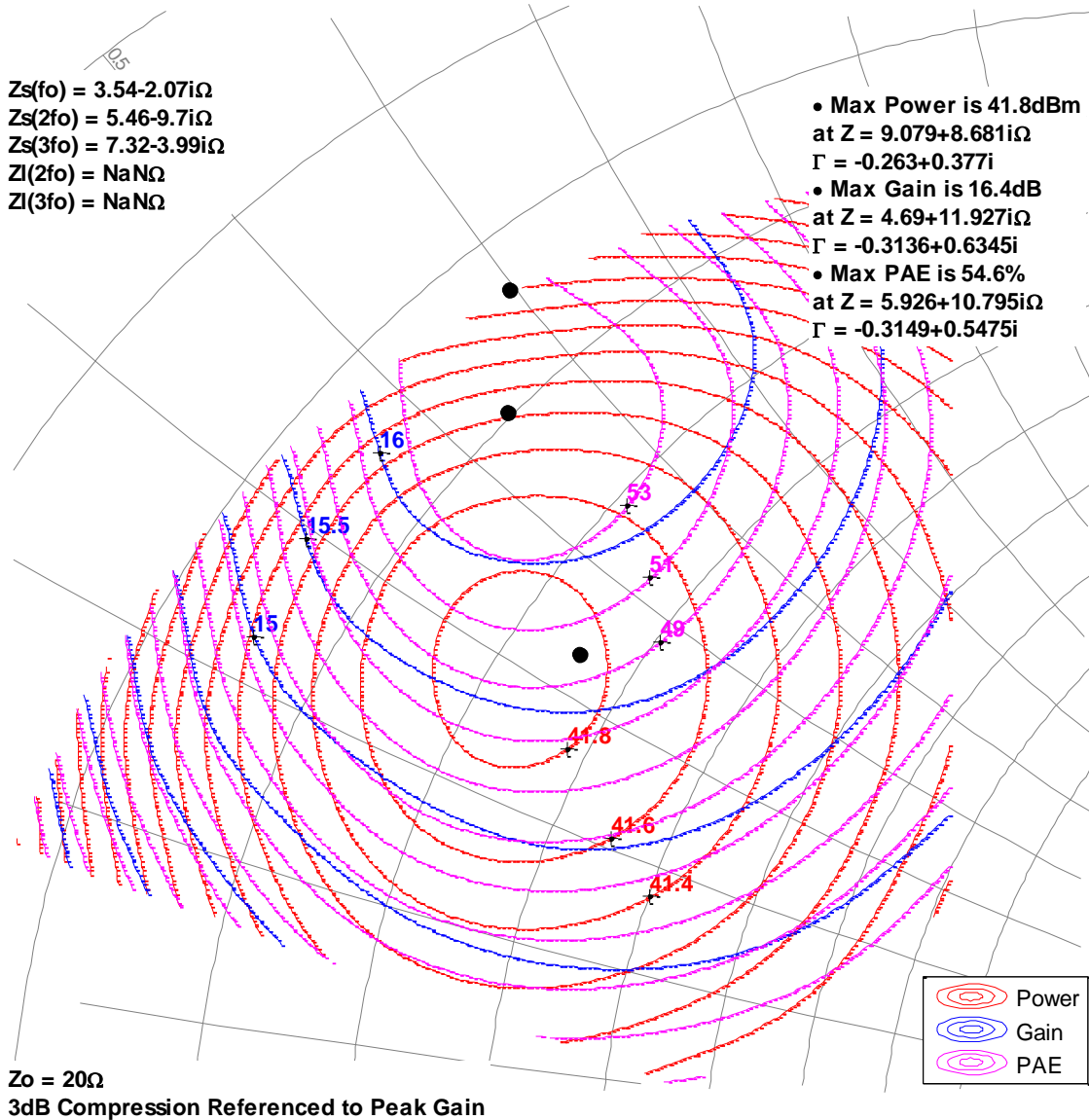


Load Pull Smith Charts^{1, 2, 3}

Notes:

1. $V_d = 50\text{ V}$, $I_{DQ} = 26\text{ mA}$, Pulsed signal with 128 μs pulse width and 10 % duty cycle. Performance is at indicated input power.
2. See page 18 for load pull and source pull reference planes. 20- Ω load pull TRL fixtures are built with 20-mil RO4350B material.
3. NaN means the impedances are either undefined or varying in load-pull system.

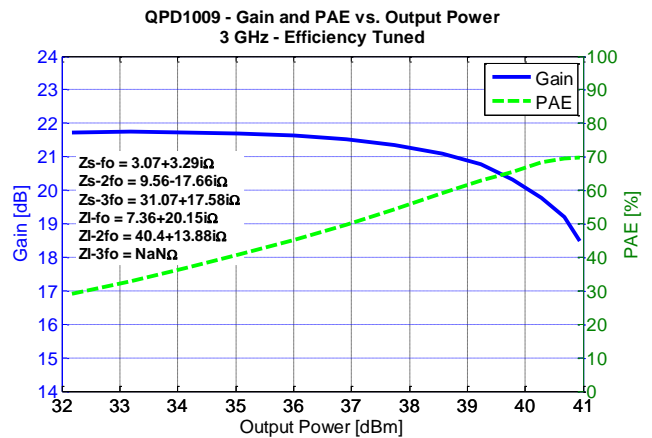
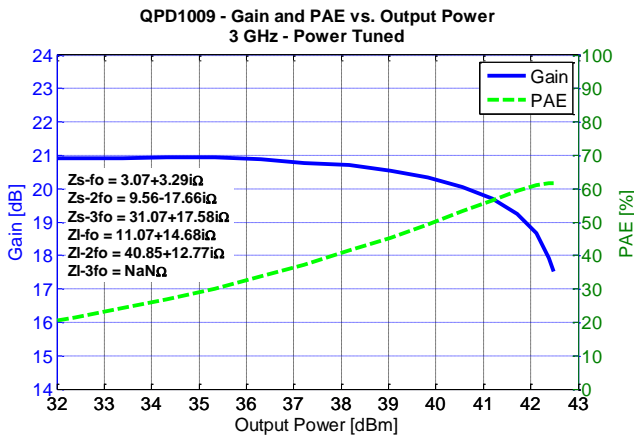
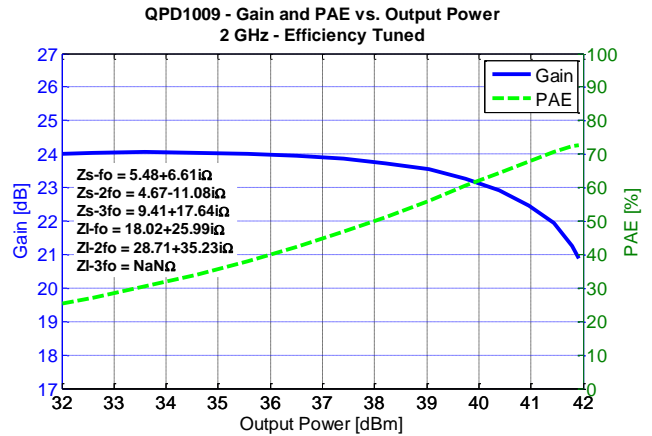
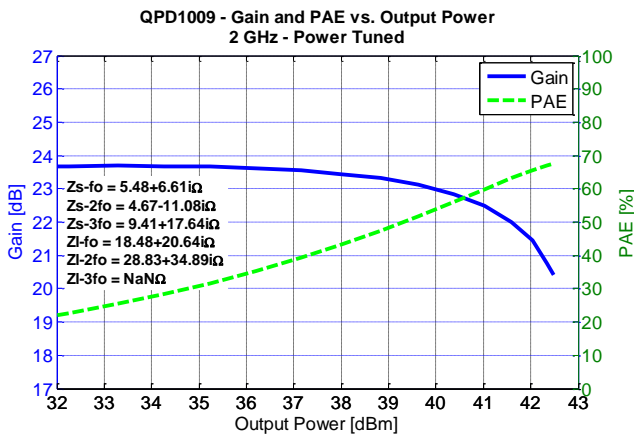
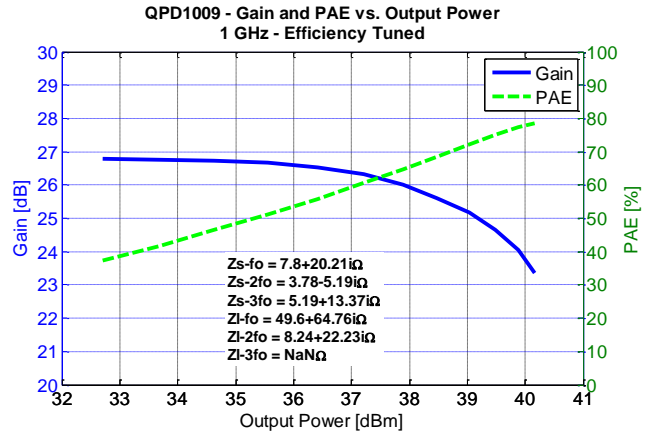
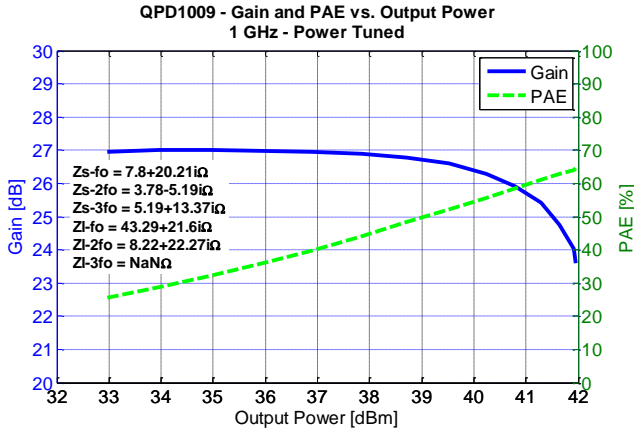
4GHz, Load-pull



Typical Performance – Load Pull Drive-up

Notes:

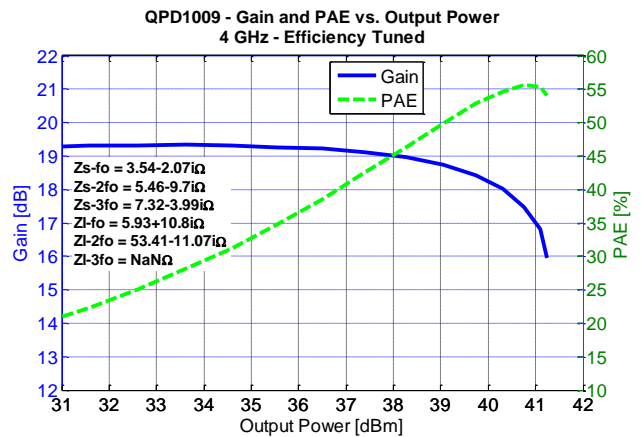
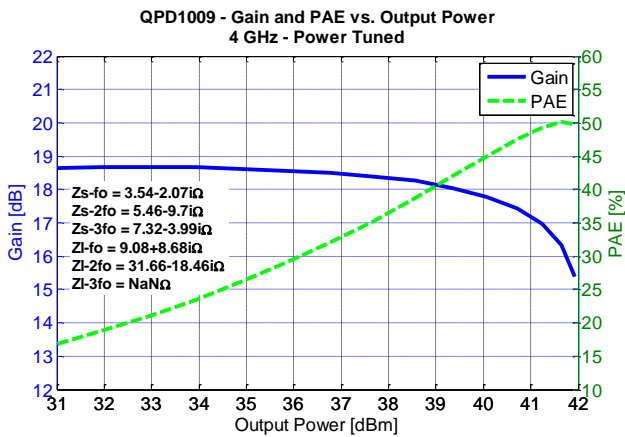
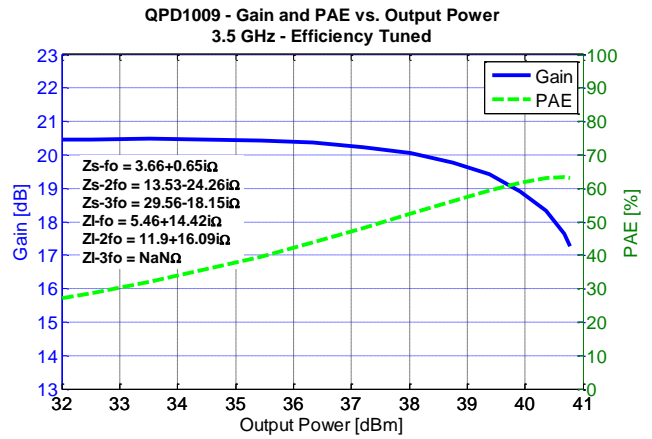
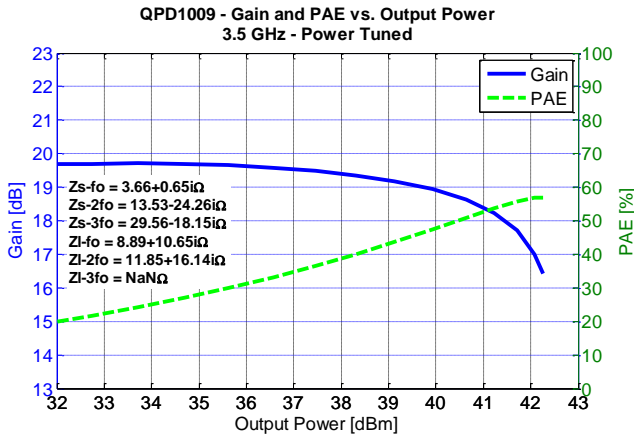
1. Pulsed signal with 128 uS pulse width and 10 % duty cycle, $V_d = 50\text{ V}$, $I_{DQ} = 26\text{ mA}$
2. See page 18 for load pull and source pull reference planes where the performance was measured.



Typical Performance – Load Pull Drive-up

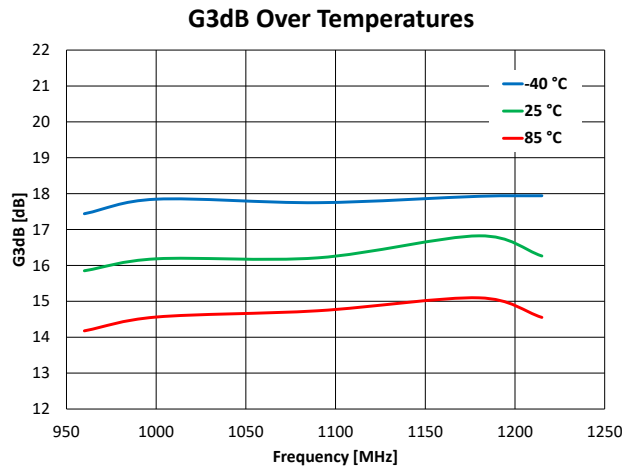
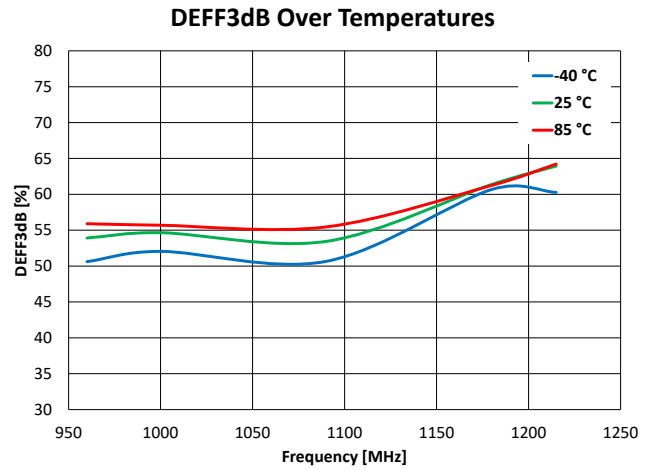
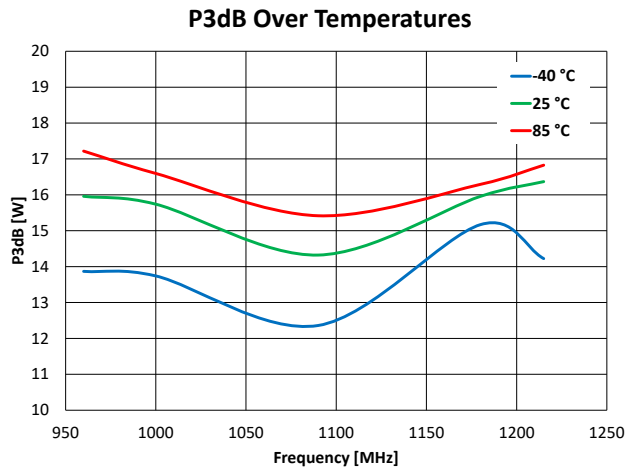
Notes:

3. Pulsed signal with 128 uS pulse width and 10 % duty cycle, $V_d = 50\text{ V}$, $I_{DQ} = 26\text{ mA}$
4. See page 18 for load pull and source pull reference planes where the performance was measured.



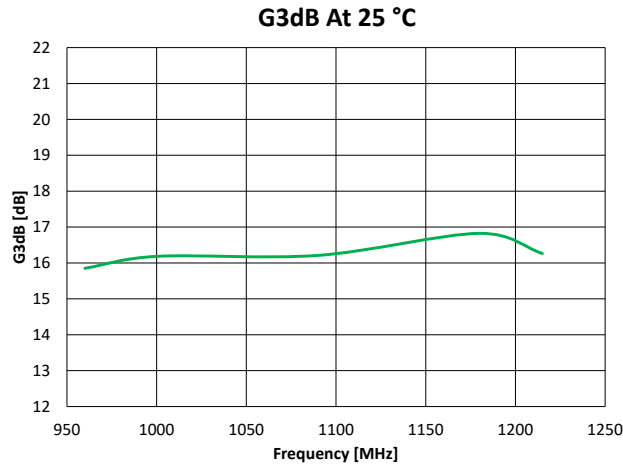
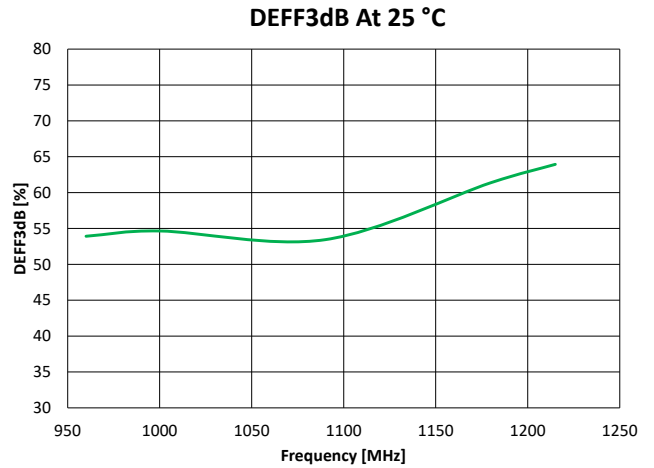
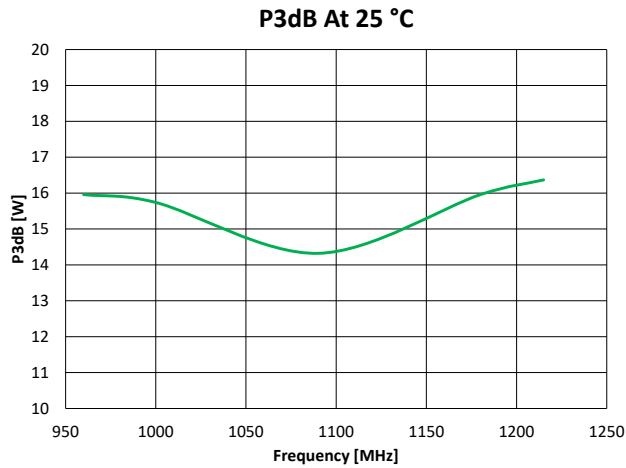
Power Driveup Performance Over Temperatures Of 0.96 – 1.215 GHz EVB¹

¹ Vd = 50 V, Idq = 26 mA, Pulse Width = 128 uS, Duty Cycle = 10 %



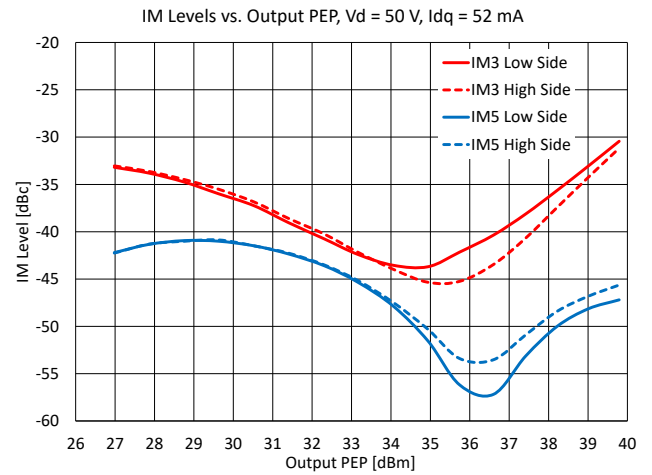
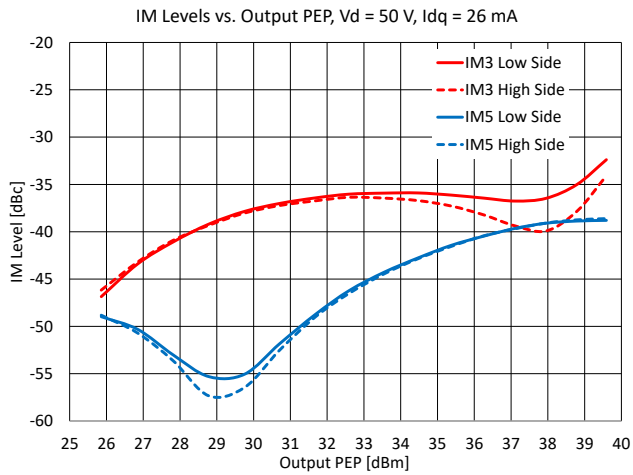
Power Driveup Performance At 25 °C Of 0.96 – 1.215 GHz EVB¹

¹ Vd = 50 V, Idq = 26 mA, Pulse Width = 128 uS, Duty Cycle = 10 %



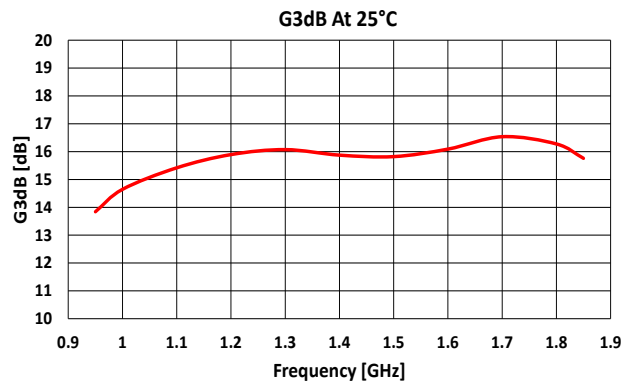
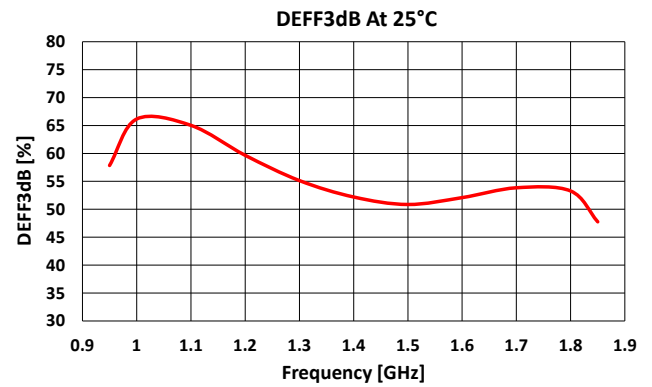
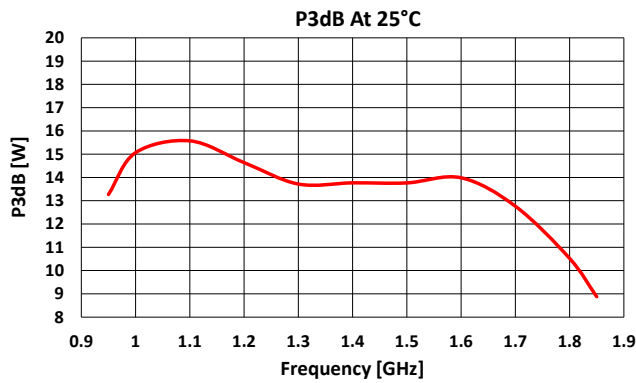
Two-Tone Performance At 25 °C Of 0.96 – 1.215 GHz EVB¹

¹ Center frequency = 1.09 GHz, Tone Separation = 1 MHz

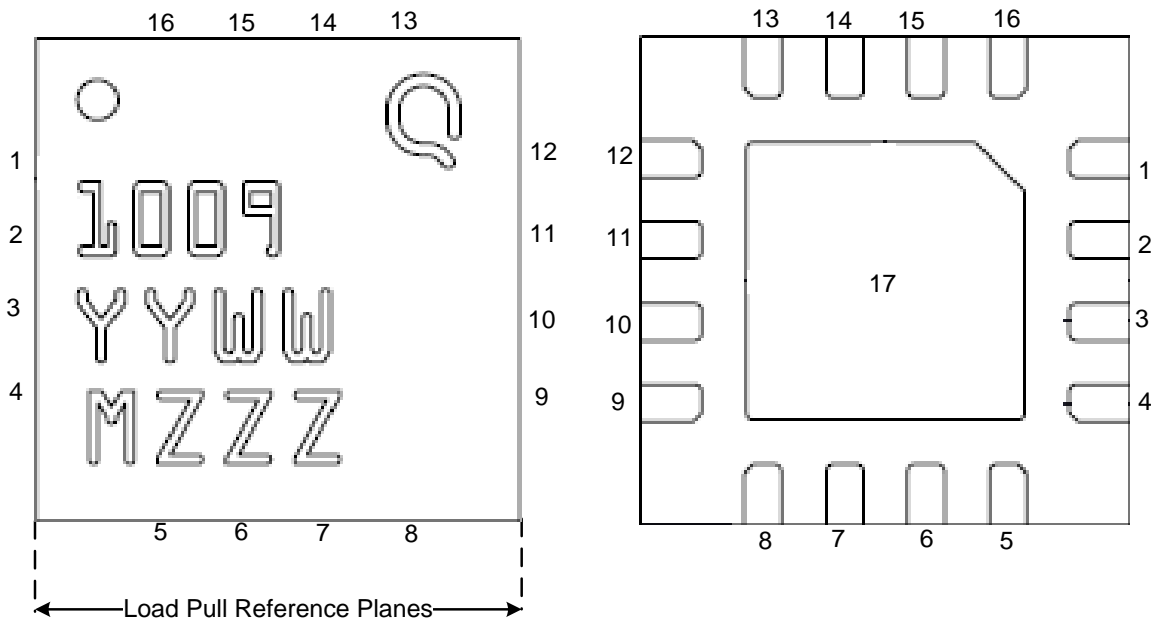


Power Driveup Performance At 25 °C Of 1.1 – 1.7 GHz EVB¹

¹ Vd = 50 V, Idq = 26 mA, Pulse Width = 128 uS, Duty Cycle = 10 %



Pin Layout ¹



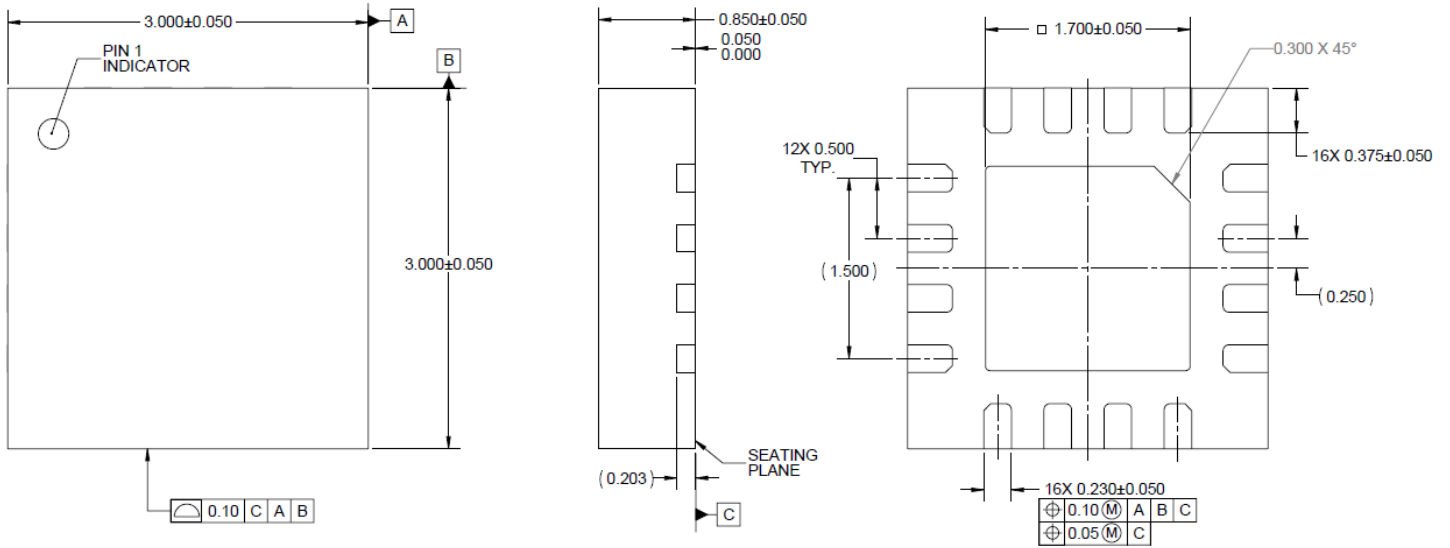
Notes:

- The QPD1009 will be marked with the “1009” designator and a lot code marked below the part designator. The “YY” represents the last two digits of the calendar year the part was manufactured, the “WW” is the work week of the assembly lot start, the “MXXX” is the production lot number, and the “ZZZ” is an auto-generated serial number.

Pin Description

Pin	Symbol	Description
2, 3	VG / RF IN	Gate voltage / RF Input
10, 11	VD / RF OUT	Drain voltage / RF Output
1, 4, 5 – 9, 12 - 16	NC	Not Connected
17	Flange	Source to be connected to ground

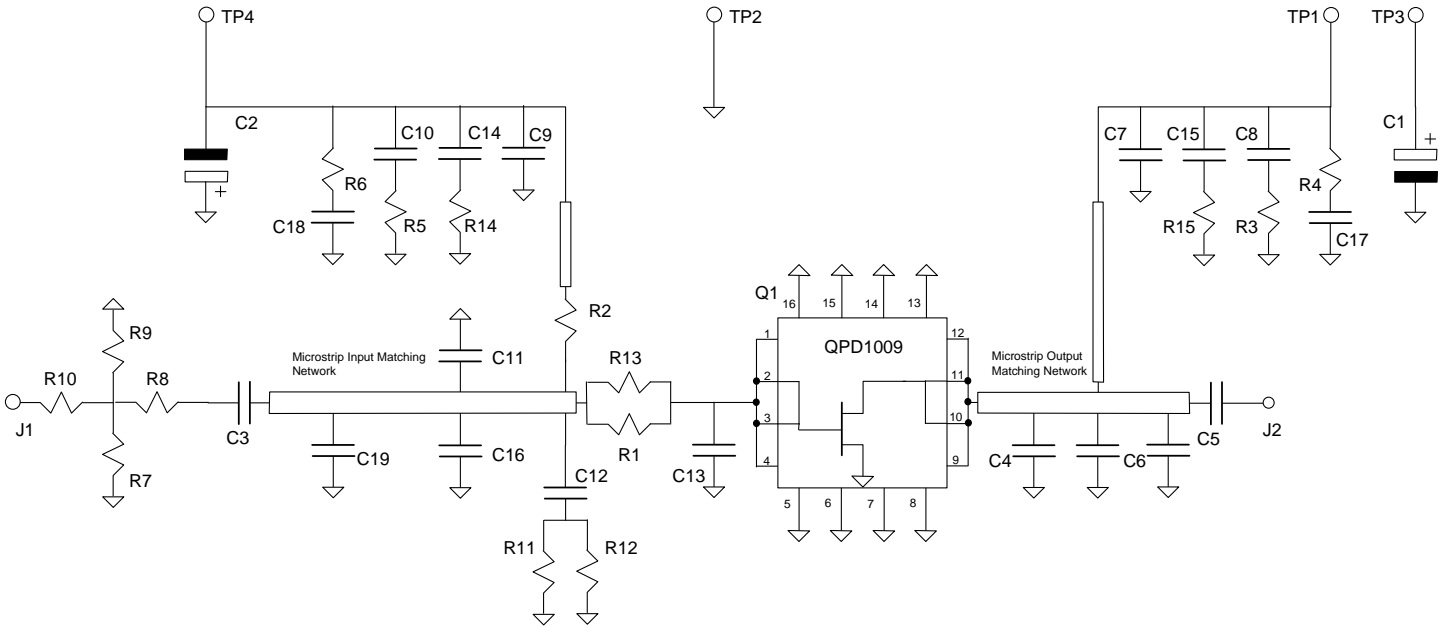
Mechanical Drawing^{1, 2, 3}



Notes:

1. All dimensions are in mm. Otherwise noted, the tolerance is ± 0.100 mm.
2. Package leads are gold plated.
3. Part is mold encapsulated.

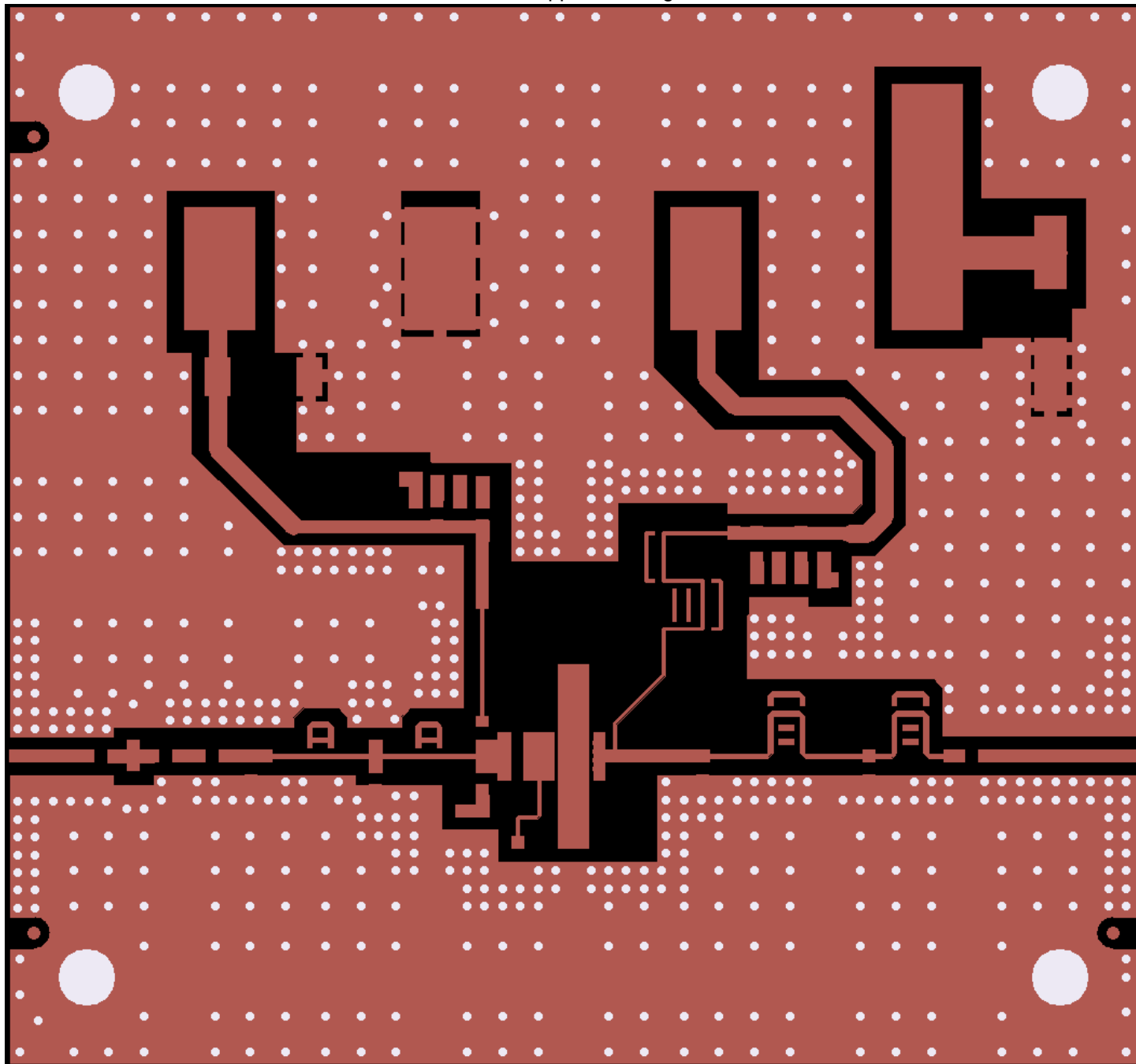
Schematic - 0.96 – 1.215 GHz EVB



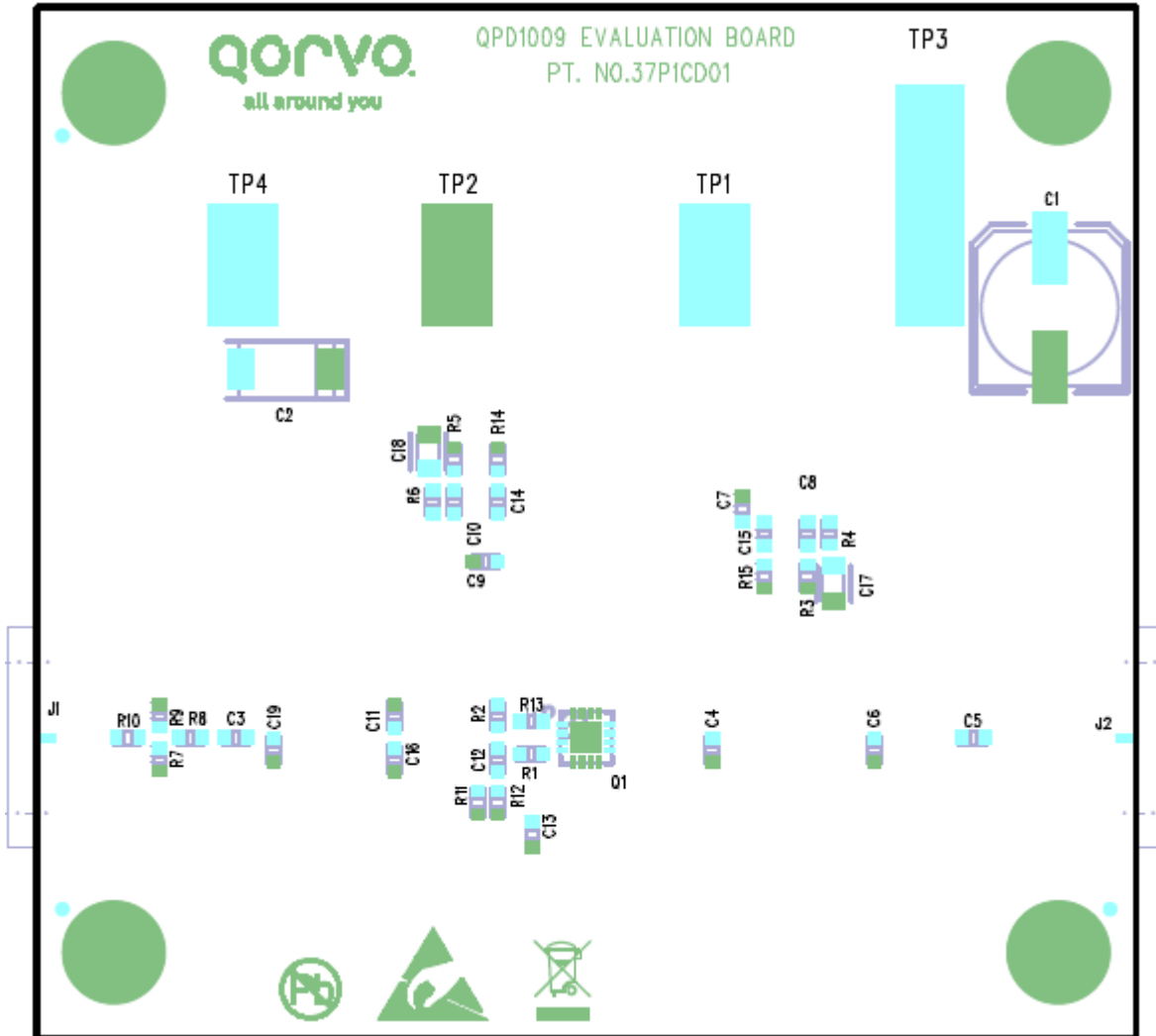
Bias-up Procedure	Bias-down Procedure
1. Set V_G to -4 V.	1. Turn off RF signal.
2. Set I_D current limit to 30 mA.	2. Turn off V_D
3. Apply 50 V V_D .	3. Wait 2 seconds to allow drain capacitor to discharge
4. Slowly adjust V_G until I_D is set to 26 mA.	4. Turn off V_G
5. Set I_D current limit to 1.5 A	
6. Apply RF.	

PCB Layout - 0.96 – 1.215 GHz EVB

Board material is RO4360G2 0.020" thickness with 1 oz copper cladding.



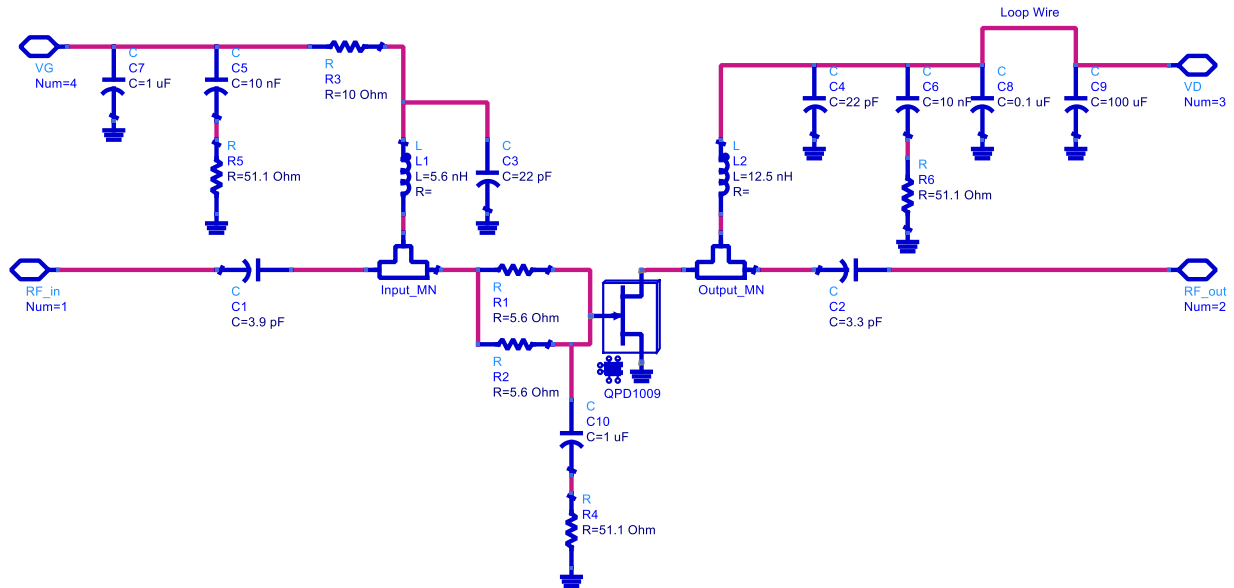
Component Placement - 0.96 – 1.215 GHz EVB



Bill Of material - 0.96 – 1.215 GHz EVB

Ref Des	Value	Description	Manufacturer	Part Number
C14, 15	100 pF	C0G 100V 5% 0603 Capacitor	AVX	06031A101JAT2A
C8 - 10	1 nF	X7R 100V 5% 0603 Capacitor	AVX	06031C102JAT2A
C17 - 18	100 nF	X7R 100V 5% 0805 Capacitor	AVX	08051C104JAT2A
C4	0.2 pF	RF NPO 250VDC ± 0.05 pF Capacitor	ATC	ATC600S0R2AT250X
C13	1.0 pF	RF NPO 250VDC ± 0.05 pF Capacitor	ATC	ATC600S1R0AT250X
C6	1.5 pF	RF NPO 250VDC ± 0.05 pF Capacitor	ATC	ATC600S1R5AT250X
C19	6.8 pF	RF NPO 250VDC ± 0.1 pF Capacitor	ATC	ATC600S6R8BT250X
C11, 16	7.5 pF	RF NPO 250VDC ± 0.1 pF Capacitor	ATC	ATC600S7R5BT250X
C3, 5, 7, 9, 12	56 pF	RF NPO 250VDC 1% Capacitor	ATC	ATC600S5650FT250X
C1	33 uF	80V SVP Capacitor	Panasonic	EEEFK1K330P
C2	10 uF	16V Tantalum Capacitor	AVX	TPSC106KR0500
J1 - 2		SMA Panel Mount 4-hole Jack	Gigalane	PSF-S00-000
R4, 6	1 Ohm	0603 1% Thick Film Resistor	ANY	
R1, 2, 8, 10, 13, 14, 15	5.1 Ohm	0603 1% Thick Film Resistor	ANY	
R3, 5	33 Ohm	0603 1% Thick Film Resistor	ANY	
R11, 12	150 Ohm	0603 1% Thick Film Resistor	ANY	
R7, 9	430 Ohm	0603 1% Thick Film Resistor	ANY	

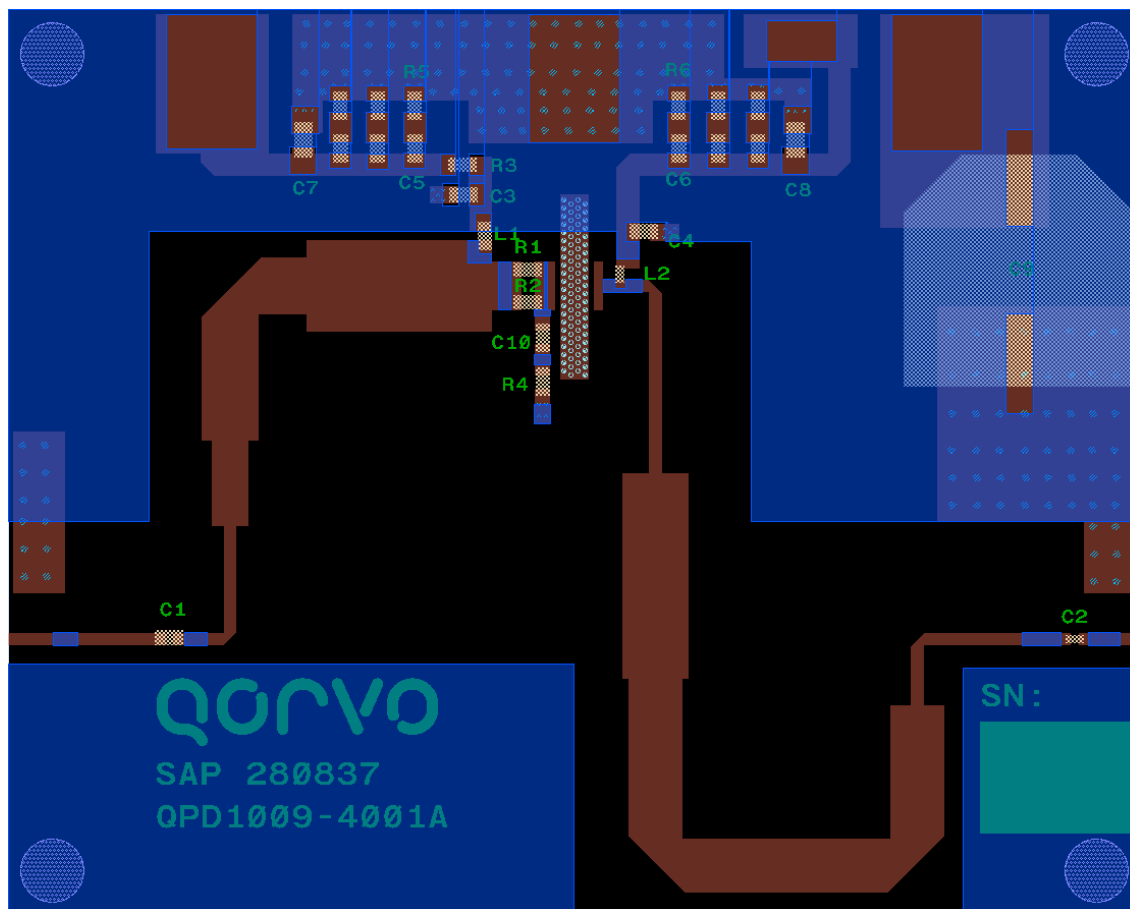
Schematic – 1.1 – 1.7 GHz EVB



Bias-up Procedure	Bias-down Procedure
2. Set V_G to -4 V.	3. Turn off RF signal.
4. Set I_D current limit to 30 mA.	4. Turn off V_D
5. Apply 50 V V_D .	5. Wait 2 seconds to allow drain capacitor to discharge
6. Slowly adjust V_G until I_D is set to 26 mA.	7. Turn off V_G
8. Set I_D current limit to 1.5 A	
9. Apply RF.	

PCB Layout – 1.1 – 1.7 GHz EVB

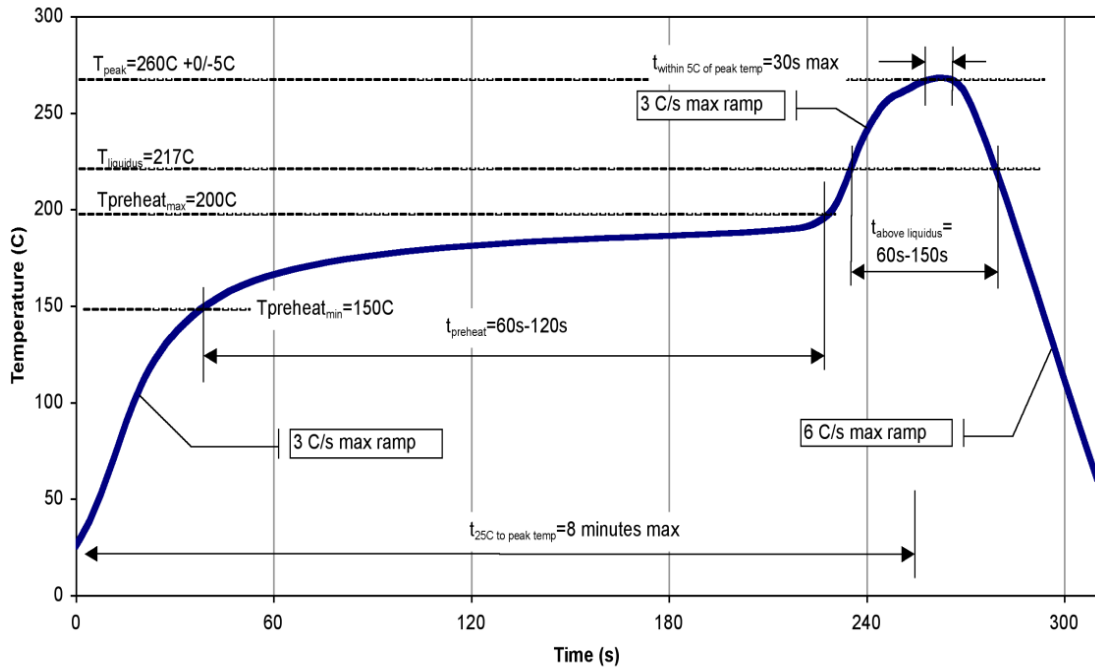
Board material is RO4360G2 0.020" thickness with 1 oz copper cladding.



Bill Of material – 1.1 – 1.7 GHz EVB

Comp. Desig.	Value	Quantity	Part number	Manufacturer
C1	3.9 pF	1	600S3R9AT250XT	ATC
C2	3.3 pF	1	600S3R3AT250XT	ATC
C3, C4	22 pF	2	600S220FT250XT	ATC
C5, C6	0.01 uF	2	ECJ-2VB2A103K	Panasonic
C7	1 uF, 25 V	1	GCM21BR71E105KA56L	Murata
C8	0.1 uF, 100 V	1	08051C104JAT2A	AVX
C9	100 uF, 63 V	1	EEETG1J101UP	Panasonic
C10	1 uF, 16 V	1	GCM188R71C105KA64D	Murata
L1	5.6 nH	1	0603CS-5N6XJEW	Coilcraft
L2	5.6 nH	1	0603HP-5N6XJLW	Coilcraft
R1, R2	5.6 Ohm	2	CRCW06035R60JNEA	Vishay
R4, R5, R6	51.1 Ohm	3	CRCW060351R1FKTA	Vishay
R3	10 Ohm	1	CRCW060310R0JNTA	Vishay
PCB		1	RO4360G2, 32 mil, 1 oz copper	Rogers

Recommended Solder Temperature Profile



Handling Precautions

Parameter	Rating	Standard
ESD – Human Body Model (HBM)	Class 1A	ANSI/ESD/JEDEC JS-001
ESD – Charged Device Model (CDM)	Class C2B, 1000 V	ANSI/ESD/JEDEC JS-002
MSL – Moisture Sensitivity Level	MSL3	JESD J-STD-020



Caution!
ESD-Sensitive Device

Solderability

Compatible with both lead-free (260°C max. reflow temp.) and tin/lead (245°C max. reflow temp.) soldering processes. Solder profiles available upon request.

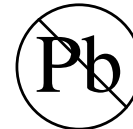
Contact plating: NiPdAu

RoHS Compliance

This part is compliant with 2011/65/EU RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment) as amended by Directive 2015/863/EU.

This product also has the following attributes:

- Lead Free
- Halogen Free (Chlorine, Bromine)
- Antimony Free
- TBBP-A (C₁₅H₁₂Br₄O₂) Free
- PFOS Free
- SVHC Free



Contact Information

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- Широкая линейка поставок активных и пассивных импортных электронных компонентов (более 30 млн. наименований);
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

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JONHON

«JONHON» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели, кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



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